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Deposition of hetero-epitaxial In_2O_3 thin films by molecular beam epitaxy

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Deposition of hetero-epitaxial In_2O_3 thin films by molecular beam epitaxy

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Highly oriented thin film In_2O_3 was heteroepitaxially grown on optically polished (100) plane of single crystalline yttria stabilized zirconia (YSZ) substrate using Molecular Beam Epitaxy (MBE). Full-width at half-maximum (FWHM) of X-ray rocking-curve showed 0.08° for In_2O_3 200 nm thick layers indicating that excellent uniformity orientation compared with the heteroepitaxially-grown In_2O_3 epitaxially deposited by the conventional methods such as electron-beam (e-beam) evaporation or sputtering method. The minimum yield ($\chi_{\min}$) of the MBE grown In_2O_3 film of Rutherford Backscattering Spectrometry (RBS) was also extremely small value 3.1%, implying the very high crystallinity.

1. INTRODUCTION

Thin film of transparent conductive oxides have been widely used as transparent conductive electrodes in various optoelectronic applications due to its high transmissivity to visible light (more than 80-90% at 550 nm) and its relatively low resistivity (lower than $4 \times 10^{-4} \Omega \text{cm}$) [1-3]. Accordingly, there has been a great deal of work investigating their preparation processes and optimizing their properties [4-7]. Most of the efforts have been focused on the oxides of indium, tin and zinc although many authors have attempted to improve the electrical properties by adding small (typically a few percent) amounts of other elements as dopants; for example $\text{In}_2\text{O}_3:\text{Sn}$ (ITO) [8], $\text{SnO}_2:\text{F}$ [9], and $\text{ZnO}:\text{Al}$ or Ga [10].

The basic physics of all these systems are similar; the desirable properties result from the oxides being n-type, wide-gap semiconductor with an optical bandgap of between 3 and 4 eV doped to give a (usually degenerate) electron gas in the conduction band. [11] Although to this extent the basic physics is understood, the knowledge of the relations between the defect state which scatter and/or produce the free electrons and the electrical

relations between the defect state which scatter and/or produce the free electrons and the electrical properties is very poor. In part this is because of the complex structure of unit cell of crystalline such as In_2O_3 (bixbyite Ia3) and the complicated nature of the conducting mechanisms in the polycrystalline structure.

Recently, well-oriented In_2O_3 films without large-angle boundaries have been fabricated using single-crystalline substrates of MgO or yttria-stabilized zirconia (YSZ) [12-14]. Tarsa et al. reported on In_2O_3 films deposited by pulsed laser deposition that XRD rocking curve measurements revealed higher uniformity of surface-normal orientation of In_2O_3 on YSZ (rocking curve FWHM = 0.29°) than the one on MgO (FWHM = 1.5°), because of the smaller lattice mismatch of $\sim 2\%$ between In_2O_3 and YSZ ($a_{\text{In}_2\text{O}_3} = 1.0118 \text{ nm}$, $2a_{\text{YSZ}} = 1.026 \text{ nm}$) than In_2O_3 and MgO ($2a_{\text{MgO}} = 0.842 \text{ nm}$) [12].

Synthesis of heteroepitaxial grown In_2O_3 film with perfectly uniform orientation and very highly crystallinity should be important in order to investigate the relations between the defect state and the electrical properties, because it enables to use RBS technique for precisely analyses of the defect state.

In this study the deposition of the heteroepitaxially grown In_2O_3 thin film on the YSZ single crystal with high uniform orientation and high crystallinity was carried out by MBE system and the characterizations of this film were also carried out. The difference in crystallinity between the heteroepitaxial film deposited by MBE system, by conventional e-beam evaporation and by sputtering technique was also studied to investigate the intricate difference of deposition techniques.

2. EXPERIMENT

Thin film In_2O_3 with thickness of about 2000 Å were deposited on optically polished (001) plane of 1mm-thick single crystalline yttria stabilized zirconia (IO/YSZ(001)) at 300°C using molecular beam epitaxy (MBE) system (ULVAC, MB63-3068). The MBE system was evacuated to the back pressure smaller than 6×10^{-10} Torr and then 1.0 sccm O_2 gas was introduced into the system and blown on the substrate controlled using mass flow controller (STEC4200). Metal In was heated to 735°C in Knudsen Cell and evaporated onto the substrate. Before starting the deposition, the oxygen gas was introduced into the MBE system for about 5 hrs. to stabilize the oxidation of In source surface. After this operation, the deposition rate was precisely maintained at 6 Å/min, about 100 times lower than the conventional e-beam evaporation, which was monitored by quartz crystal oscillator [ULVAC, CRTM-5000]. The deposition In_2O_3 films with the approximately same thickness were also deposited by a conventional e-beam evaporation with sintered In_2O_3 pellets. All these films had epitaxially grown was certified by standard $\theta/2\theta$ and pole figure XRD analyses.

The microstructure of the IO/YSZ(001) deposited by MBE and e-beam evaporation were analyzed by plane view SEM image using Hitachi S900 FE-SEM. X-ray rocking curves were measured for precise evaluations on the uniformity of the crystalline grain orientation of the IO/YSZ(001) deposited by MBE system and e-beam evaporation. The crystallographic disorder of MBE deposited heteroepitaxial In_2O_3 films was investigated by Rutherford Backscattering Spectrometry (RBS) using a High Voltage Engineering Model AN-2500 Positive Ion Accelerator. The ion channeling was carried out using 2.0 MeV He^{2+} ion beam at a scattering angle of 160°.

3. RESULTS

Fig.1 shows standard $\theta/2\theta$ (Fig.1(a)) and pole-figure (Fig.1(b),(c)) XRD peaks of the IO/YSZ(001) deposited by MBE system. These peaks show that the film had grown with excellent in-plane crystalline orientation indicating heteroepitaxial growth. Figures 2(a,b) show the SEM surface images of the IO/YSZ(001) deposited by e-beam evaporation (Fig.2(a)) and MBE system (Fig.2(b)). The IO/YSZ(001) deposited by e-beam evaporation consisted of nonequilibrium shaped grains with size of 50-100 nm. Whereas the IO/YSZ(001) deposited by MBE system consisted of in plane oriented, square-shaped grains indicating an excellent in-plane crystalline orientation of this film. Figures 3(a,b) show the results of X-ray rocking curve measurement for IO/YSZ(001) deposited by e-beam evaporation (Fig.3(a)) and by MBE deposition (Fig.3(b)). These results (rocking curve FWHM = 0.08° for the film deposited by MBE system and 0.46° for the film deposited by e-beam evaporation) indicate that the heteroepitaxial IO/YSZ(001) deposited by MBE system has grown with much higher uniformity of crystalline orientation with the comparison of e-beam evaporated film.

An ion channeling spectrum from the heteroepitaxial In_2O_3 film deposited on YSZ(001) substrate by MBE deposition is shown in Fig.4.

Fig.1 Standard $\theta/2\theta$ (a), pole-figure for (400) diffraction (b) and (002) diffraction (c) of the IO/YSZ(001) deposited by MBE.

Fig. 2 SEM surface images of the IO/YSZ(001) deposited by e-beam evaporation (a) and MBE system (b).

Fig. 3 X-ray rocking curve measured on the (004) In_2O_3 XRD peak of the film deposited by (a) e-beam evaporation and (b) MBE system.

Fig. 4 Random and $\langle 100 \rangle$ aligned RBS spectra for IO/YSZ(001) film deposited by MBE system.

The minimum yield from the MBE deposited film is 3.1%, which is better than that from the e-beam evaporated film (4.1%). The difference in minimum yield is direct evidence that the MBE deposited film has fewer crystal imperfection.

4. DISCUSSION

Heteroepitaxial IO/YSZ(001) film deposited by MBE system showed both the much more uniform orientation and the higher crystallinity compared with films of approximately the same thickness deposited by a conventional e-beam evaporation, reasons for which must be worth discussing in order to evaluate the key factors for depositing the high quality epitaxial films.

We have reported the improvement in the uniformity of crystalline orientation and the crystallinity ($\chi_{\min}=4.5\%$) of the e-beam evaporated heteroepitaxial tin-doped indium oxide film (ITO/YSZ(001)) as compared with the sputtered ITO/YSZ(001) (FWHM=0.56°, $\chi_{\min}=8\%$), and concluded that the reason for this improvement was bombardment of the energetic particles in sputtering processes. [15]

In the sputtering processes two kinds of high-energy particles have been reported to bombard the growing film surface, i.e. (1) high energy neutrals (Ar^0) produced by neutralization of positive ions (Ar^+) at the surface of the target [16] and (2) energetic negative ions (O^-) accelerated in the cathode sheath to the substrate surface [17]. Since these bombardment of energetic particles during the film growth could perturb the growth surface and

generate the secondary nucleation, the uniformity of crystalline orientation and the crystallinity should be disordered in the sputter deposition[18]. On the contrary, there are no high-energy particles in the e-beam evaporation process, which enable the heteroepitaxial growth with high uniformity of crystalline orientation and high crystallinity.

However, in the case of e-beam evaporation method where a source pellets is heated by electron beam irradiation, precisely control of the deposition rate is very difficult. The degree of oxidation of an oxide film is decided by the balance between deposition rate and reactive gas pressure, so the instability of deposition rate also causes the perturbation of the growing surface. On the other hand, in the MBE process, the deposition rate was about 100 times lower than e-beam evaporation and was precisely controlled. Accordingly, in the MBE system, the synthesis of perfectly stoichiometric crystal structure could be attained because of the regularity of supplying ratio and rate of In/O during film growth.

Moreover, it has been reported that the ITO films deposited on glass substrate at higher water partial pressure have a large amount of In-OH and Sn-O-H bonds, which is supposed to exist at the interface between the films and the substrates resulted from the increasing chemically adsorbed water on the glass surfaces[19]. In the extremely low back pressure process of the MBE system, there might be few amounts of OH bonds on substrate surface, which should enable the ideal heteroepitaxial growth on a clean substrate surface.

MBE process is considered to have such advantages compared with the other deposition techniques, so the film with extremely high uniform orientation and highly crystallinity could be deposited.

5. CONCLUSIONS

Heteroepitaxial growth of the In_2O_3 film was achieved on YSZ(100) substrate using Molecular Beam Epitaxy, which enable to control the deposition rate precisely. FWHM value 0.08° of X-ray rocking curve have been obtained for this heteroepitaxial growth film. RBS channeling minimum yield ($\chi_{\min}$) of the film was also quite small value of 3.1% implying that the film deposited by MBE has fewer crystal defects. The comparison with the results on the films using electron beam evaporation and sputtering technique revealed that MBE films had the perfectly uniform

orientation and very highly crystallinity. The suppression of damages caused by the energetic particle bombardments during the film growth, the precise control of In/O supplying ratio during the film growth and the deposition under ultra high vacuum were proved to be important key factors to deposit heteroepitaxial grown In_2O_3 film with extremely highly uniform orientation and high crystallinity.

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